SCLS158C - DECEMBER 1982 - REVISED FEBRUARY 2000

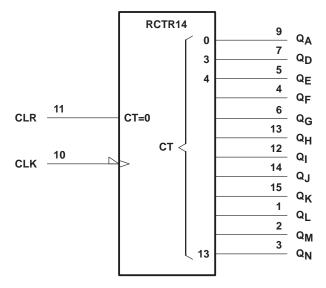
**Package Options Include Plastic** Small-Outline (D), Shrink Small-Outline (DB), Thin Shrink Small-Outline (PW), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) DIPs

### description

These devices are 14-stage binary ripple-carry counters that advance on the negative-going edge of the clock pulse. The counters are reset to zero (all outputs low) independently of the clock (CLK) input when the clear (CLR) input goes high.

The SN54HC4020 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74HC4020 is characterized for operation from -40°C to 85°C.

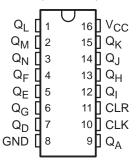
### logic symbol<sup>†</sup>



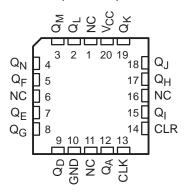
† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, DB, J, N, PW, and W packages.

### SN54HC4020 . . . J OR W PACKAGE SN74HC4020 . . . D. DB. N. OR PW PACKAGE (TOP VIEW)



### SN54HC4020 . . . FK PACKAGE (TOP VIEW)



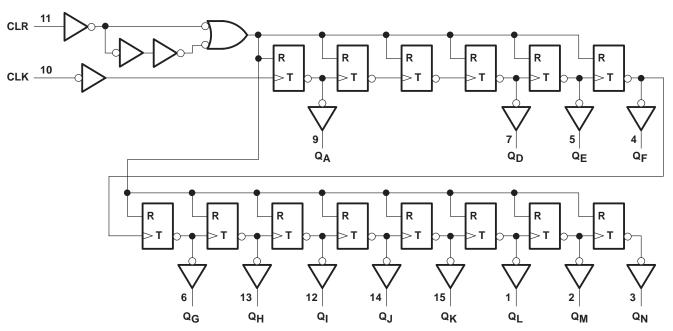
NC - No internal connection



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### logic diagram (positive logic)



Pin numbers shown are for the D, DB, J, N, PW, and W packages.

## absolute maximum ratings over operating free-air temperature range†

Supply voltage range, V <sub>CC</sub>		. $-0.5 \text{ V}$ to 7 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) (se	ee Note 1)	±20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CO</sub>		
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	· · · · · · · · · · · · · · · · · · ·	±25 mA
Continuous current through V <sub>CC</sub> or GND		±50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2):	D package	73°C/W
	DB package	82°C/W
	N package	67°C/W
	PW package	108°C/W
Storage temperature range, T <sub>stg</sub>		–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.



### recommended operating conditions (see Note 3)

			SN	SN54HC4020			SN74HC4020		
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		2	5	6	2	5	6	V
	V <sub>IH</sub> High-level input voltage	V <sub>CC</sub> = 2 V	1.5			1.5			
VIH		V <sub>CC</sub> = 4.5 V	3.15			3.15			V
		VCC = 6 V	4.2			4.2			
		V <sub>CC</sub> = 2 V	0		0.5	0		0.5	
VIL	V <sub>IL</sub> Low-level input voltage	V <sub>CC</sub> = 4.5 V	0		1.35	0		1.35	V
		VCC = 6 V	0		1.8	0		1.8	
٧ <sub>I</sub>	Input voltage		0		VCC	0		VCC	V
٧o	Output voltage		0		VCC	0		VCC	V
		V <sub>CC</sub> = 2 V	0		1000	0		1000	
t <sub>t</sub> Input transition (ri	Input transition (rise and fall) time	V <sub>CC</sub> = 4.5 V	0		500	0		500	ns
		VCC = 6 V	0		400	0		400	
TA	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS		Vaa	T <sub>A</sub> = 25°C			SN54HC4020		SN74HC4020		
PARAMETER	1551 60	NDITIONS	Vcc -		TYP	MAX	MIN	MAX	MIN	MAX	UNIT
	VOH VI = VIH or VIL		2 V	1.9	1.998		1.9		1.9		
		$I_{OH} = -20  \mu A$	4.5 V	4.4	4.499		4.4		4.4		
Voн			6 V	5.9	5.999		5.9		5.9		V
		$I_{OH} = -4 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84		
		$I_{OH} = -5.2 \text{ mA}$	6 V	5.48	5.8		5.2		5.34		
		I <sub>OL</sub> = 20 μA	2 V		0.002	0.1		0.1		0.1	
			4.5 V		0.001	0.1		0.1		0.1	
V <sub>OL</sub>	$V_I = V_{IH}$ or $V_{IL}$		6 V		0.001	0.1		0.1		0.1	V
		$I_{OL} = 4 \text{ mA}$	4.5 V		0.17	0.26		0.4		0.33	
		$I_{OL} = 5.2 \text{ mA}$	6 V		0.15	0.26		0.4		0.33	
l <sub>l</sub>	$V_I = V_{CC}$ or 0		6 V		±0.1	±100		±1000		±1000	nA
lcc	$V_I = V_{CC}$ or 0,	I <sub>O</sub> = 0	6 V			8		160		80	μΑ
Ci			2 V to 6 V		3	10		10		10	pF

# SN54HC4020, SN74HC4020 14-BIT ASYNCHRONOUS BINARY COUNTERS

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# timing requirements over recommended operating free-air temperature range (unless otherwise noted)

			\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	T <sub>A</sub> = :	25°C	SN54H	C4020	SN74H	C4020	UNIT
			VCC	MIN	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V	0	5.5	0	3.7	0	4.3	
f <sub>clock</sub> Clock frequency		4.5 V	0	28	0	19	0	22	MHz	
			6 V	0	33	0	22	0	25	
		CLK high or low	2 V	90		135		115		
			4.5 V	18		27		23		
١.	Pulse duration			6 V	15		23		20	
t <sub>W</sub>	ruise duration	CLR high	2 V	70		105		90		115
			4.5 V	14		21		18		
		6 V	12		18		25			
			2 V	60		90		75		
t <sub>su</sub>	t <sub>SU</sub> Setup time, CLR inactive before CLK↓		4.5 V	12		18		15		ns
			6 V	10		15		13		

# switching characteristics over recommended operating free-air temperature range, $C_L$ = 50 pF (unless otherwise noted) (see Figure 1)

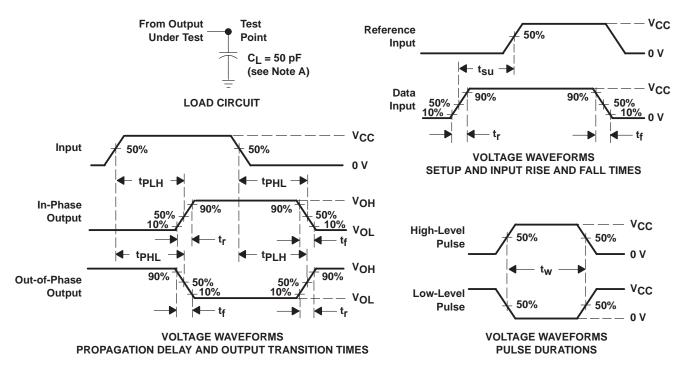
PARAMETER	FROM	то	Vaa	T	\ = 25°C	;	SN54HC4020		SN74HC4020		UNIT
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V	5.5	10		3.7		4.3		
f <sub>max</sub>			4.5 V	28	45		19		22		MHz
			6 V	33	53		22		25		
<sup>t</sup> pd			2 V		62	150		225		190	
	CLK	Q <sub>A</sub>	4.5 V		16	30		45		38	38 ns 32
			6 V		12	26		38		32	
			2 V		63	140		210		175	
<sup>t</sup> PHL	CLR	Any	4.5 V		17	28		42		35	ns
			6 V		13	24		36		30	
		Any	2 V		28	75		110		95	
t <sub>t</sub>			4.5 V		8	15		22		19	ns
			6 V		6	13		19		16	

# operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance	No load	88	pF



### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and test-fixture capacitance.

- B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \Omega$ ,  $t_r = 6$  ns,  $t_f = 6$  ns.
- C. For clock inputs, f<sub>max</sub> is measured when the input duty cycle is 50%.
- D. The outputs are measured one at a time with one input transition per measurement.
- E. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms

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